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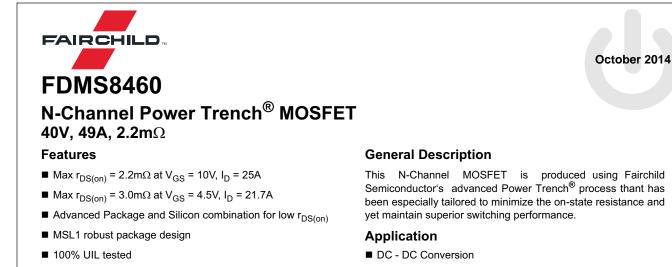


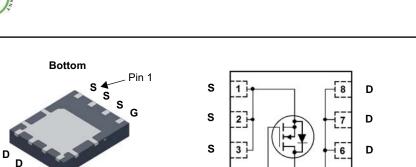
## **ON Semiconductor**®

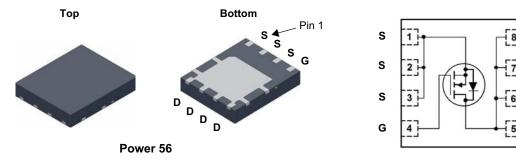
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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="mailto:www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="mailto:Fairchild\_questions@onsemi.com">Fairchild\_questions@onsemi.com</a>.

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#### MOSFET Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			40	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
I <sub>D</sub>	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25°C		49		
	-Continuous (Silicon limited)	T <sub>C</sub> = 25°C		167		
	-Continuous	T <sub>A</sub> = 25°C	(Note 1a)	25	— A	
	-Pulsed			160		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	864	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25°C		104	W	
	Power Dissipation	T <sub>A</sub> = 25°C	(Note 1a)	2.5		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

RoHS Compliant

$R_{\theta JC}$	Thermal Resistance, Junction to Case		1.2	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	C/VV

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS8460	FDMS8460	Power 56	13"	12 mm	3000 units

D

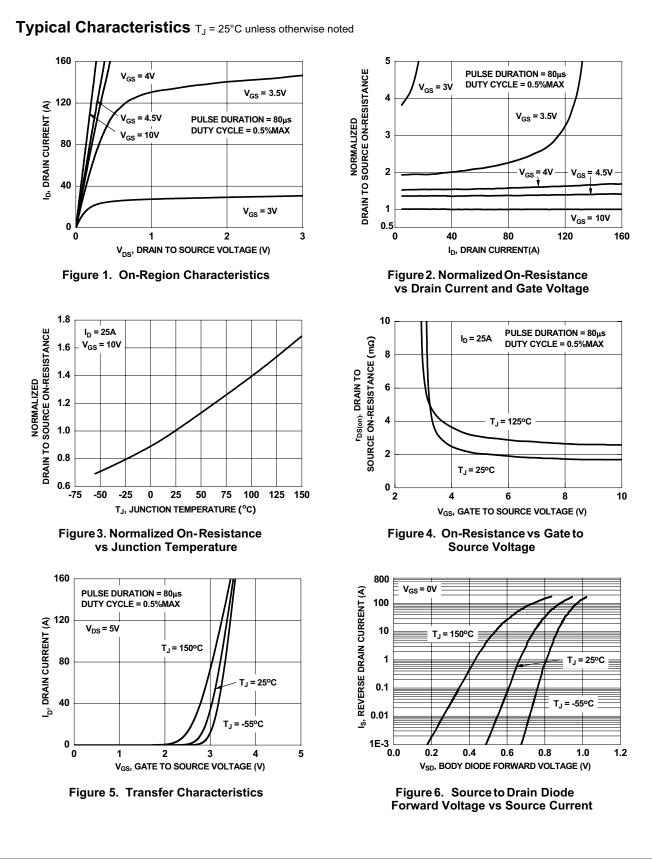
	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	40			V	
∆BV <sub>DSS</sub>	Breakdown Voltage Temperature			22			
$\Delta T_J$	Coefficient	$I_D = 250 \mu A$ , referenced to $25^{\circ}C$		32		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{GS} = 0V, V_{DS} = 32V,$			1	μΑ	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1.0	1.9	3.0	V	
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage			-			
$\Delta T_J$	Temperature Coefficient	$I_D = 250 \mu A$ , referenced to $25^{\circ}C$		-7.5		mV/°0	
r <sub>DS(on)</sub>		V <sub>GS</sub> = 10V, I <sub>D</sub> = 25A		2.0	2.2		
	Static Drain to Source On Resistance	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 21.7A		2.6	3.0		
		$V_{GS} = 10V, I_D = 25A, T_J = 125^{\circ}C$ 2.6		2.6	3.3	1	
9 <sub>FS</sub>	Forward Transconductance	$V_{DD} = 5V, I_D = 25A$		137		S	
Dunamia	Characteristics						
-	Characteristics			5415	7205		
C <sub>iss</sub>	Input Capacitance Output Capacitance	- V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V,		1470	1955	pF pF	
C <sub>oss</sub>	Reverse Transfer Capacitance	f = 1MHz		1470	250	pr pF	
C <sub>rss</sub>	Gate Resistance	f = 1MHz	0.1	1.4	3.1	Ω	
R <sub>g</sub> Switching	Characteristics		0.1		0.1		
t <sub>d(on)</sub>	Turn-On Delay Time			19	35	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 20V, I <sub>D</sub> = 25A,		9	19	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10V, R_{GEN} = 6\Omega$		48	78	ns	
t <sub>f</sub>	Fall Time			7	14	ns	
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> = 0V to 10V		78	110	nC	
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0V \text{ to } 4.5V$ $V_{DD} = 20V,$		36	51	nC	
Q <sub>gs</sub>	Gate to Source Charge	$I_D = 25A$		15		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			10		nC	
•	-						
Drain-Sol	urce Diode Characteristics			0.8			
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 25A$ (Note 2)	· ·		1.3	v	
	_	$V_{GS} = 0V, I_S = 2.1A$ (Note 2)		0.7	1.2	<u> </u>	
t <sub>rr</sub>	Reverse Recovery Time	— I <sub>F</sub> = 25A, di/dt = 100A/μs		53	85	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	•		40	64	nC	

2. Pulse Test: Pulse Width <  $300\mu s,$  Duty cycle < 2.0%.

3. Starting T<sub>J</sub> = 25°C, L = 3mH, I<sub>AS</sub> = 24A, V<sub>DD</sub> = 40V, V<sub>GS</sub> = 10V

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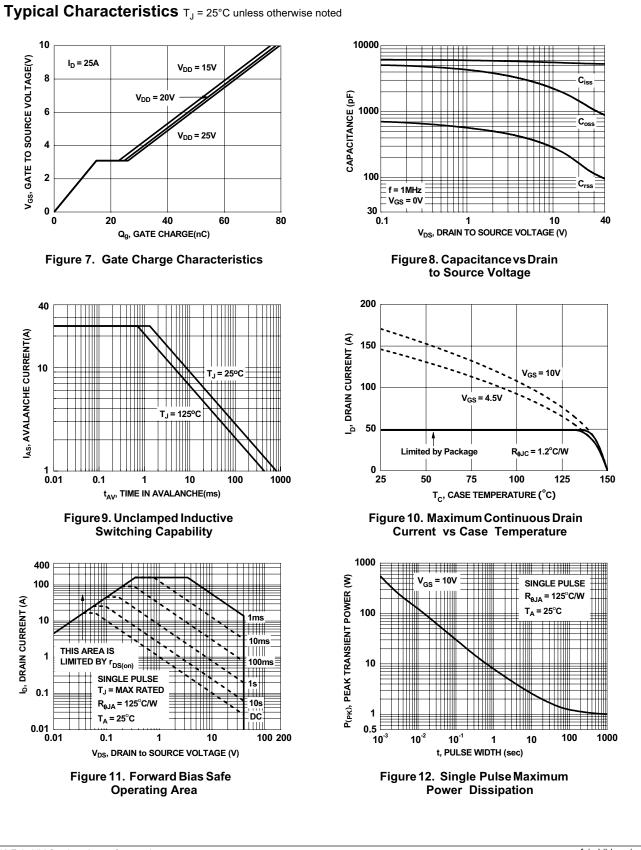
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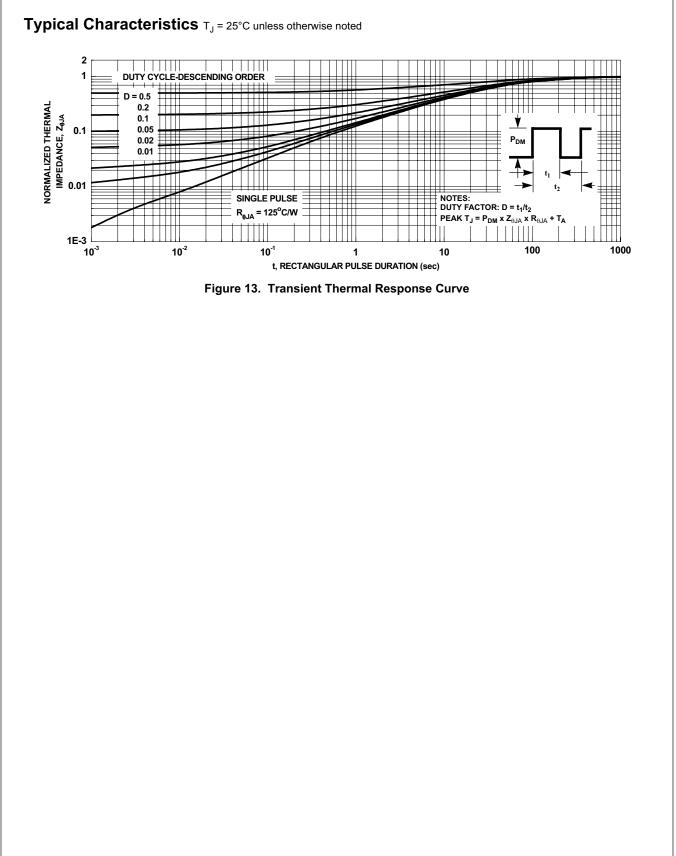
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